

# OKI Semiconductor

**FEDR27V1602F-01-02**

Issue Date: Jul. 9, 2004

## MR27V1602F

**1,048,576-Word × 16-Bit or 2,097,152-Word × 8-Bit One Time PROM**

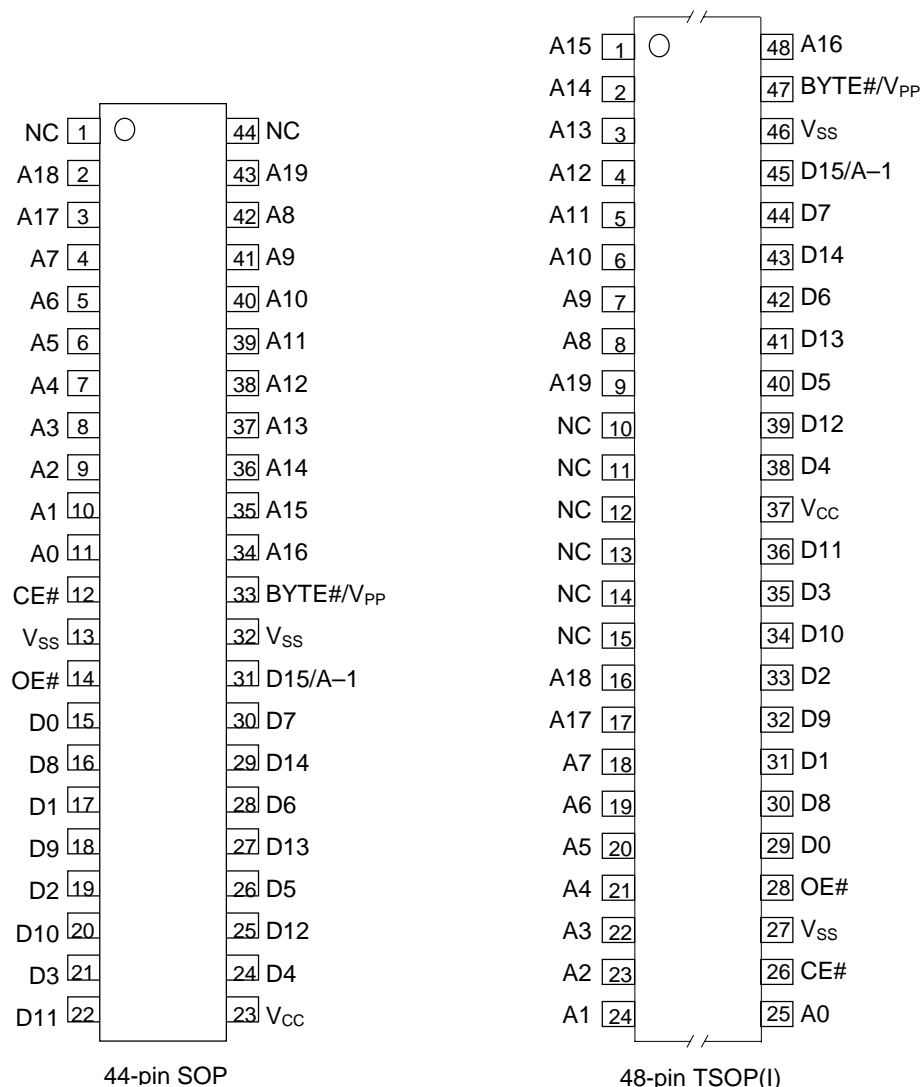
### GENERAL DESCRIPTION

The MR27V1602F is a 16 Mbit electrically One Time Programmable Read-Only Memory that can be electrically switched between 1,048,576-word × 16-bit and 2,097,152-word × 8-bit by the state of the BYTE# pin. The MR27V1602F supports high speed asynchronous read operation using a single 3.3V power supply.

### FEATURES

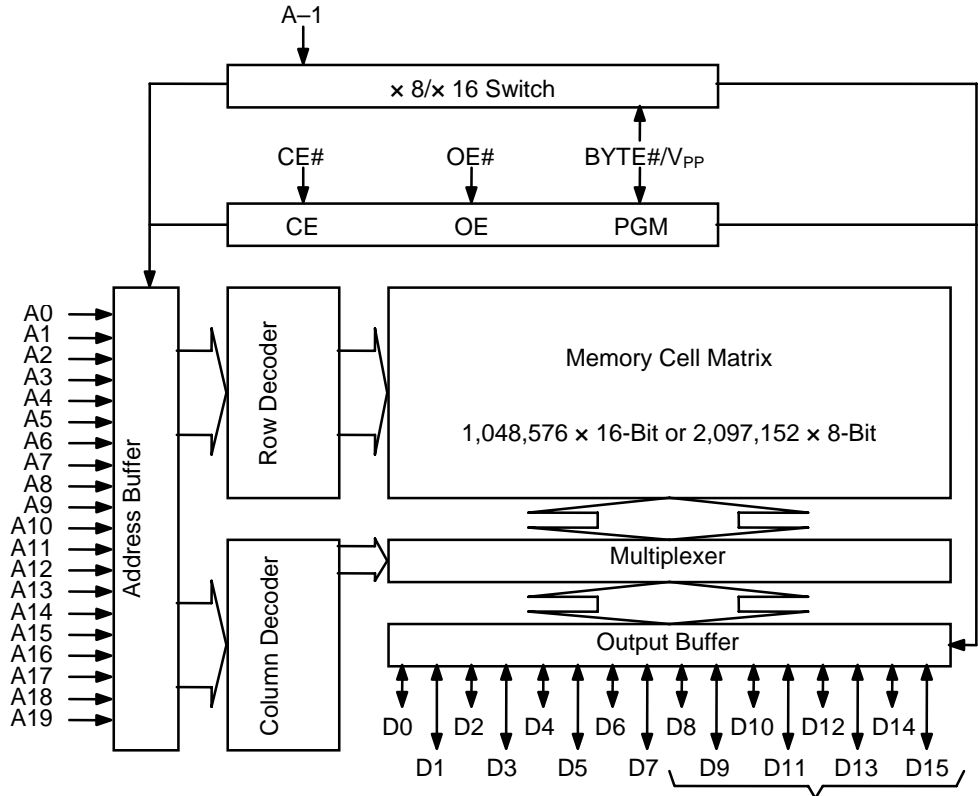
- 1,048,576-word × 16-bit/2,097,152-word × 8-bit electrically switchable configuration
- +3.3 V power supply
- Access time                      80 nS MAX
- Operating current                16 mA MAX (5MHz)
- Standby current                 10 µA MAX
- Input/Output TTL compatible
- Tri-state output
- Packages:
  - 44-pin plastic SOP (SOP44-P-600-1.27-K)                      (MR27V1602FMA)
  - 48-pin plastic TSOP (TSOP(1)48-P-1220-0.50-1K)            (MR27V1602FTN)

## PIN CONFIGURATION (TOP VIEW)



Pin name	Functions
D15/A-1	Data output/Address input
A0 to A19	Address input
D0 to D14	Data output
CE#	Chip enable
OE#	Output enable
BYTE#/V <sub>PP</sub>	Mode switch/Program power supply voltage
V <sub>CC</sub>	Power supply voltage
V <sub>SS</sub>	GND
NC	Non connection

# BLOCK DIAGRAM



In 8-bit output mode, these pins are placed in a high-Z state and pin D15 functions as the A-1 address pin.

# FUNCTION TABLE

Mode	CE#	OE#	BYTE#/V <sub>PP</sub>	V <sub>CC</sub>	D0 to D7	D8 to D14	D15/A-1
Read (16-Bit)	L	L	H	3.3 V	D <sub>OUT</sub>		
Read (8-Bit)	L	L	L		D <sub>OUT</sub>	Hi-Z	L/H
Output disable	L	H	H		Hi-Z		*
			L				
Standby	H	*	H		Hi-Z		*
			L				
Program	L	H	8.2 V	4.0 V	D <sub>IN</sub>		
Program inhibit	H	H			Hi-Z		
Program verify	H	L			D <sub>OUT</sub>		

\*: Don't Care (H or L)

**ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Ta	—	0 to 70	°C
Storage temperature	Tstg		−55 to 125	°C
Input voltage	V <sub>I</sub>	relative to V <sub>SS</sub>	−0.5 to V <sub>CC</sub> +0.5	V
Output voltage	V <sub>O</sub>		−0.5 to V <sub>CC</sub> +0.5	V
Power supply voltage	V <sub>CC</sub>		−0.5 to 5	V
Program power supply voltage	V <sub>PP</sub>		−0.5 to 9.0	V
Power dissipation per package	P <sub>D</sub>	Ta = 25°C	1.0	W
Output short circuit current	I <sub>OS</sub>	—	10	mA

**RECOMMENDED OPERATING CONDITIONS**

(Ta = 0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V <sub>CC</sub> power supply voltage	V <sub>CC</sub>	V <sub>CC</sub> = 3.0 to 3.6 V	3.0	—	3.6	V
V <sub>PP</sub> power supply voltage	V <sub>PP</sub>		−0.5	—	V <sub>CC</sub> +0.5	V
Input “H” level	V <sub>IH</sub>		2.2	—	V <sub>CC</sub> +0.5*	V
Input “L” level	V <sub>IL</sub>		−0.5**	—	0.6	V

Voltage is relative to V<sub>SS</sub>.\* : V<sub>CC</sub>+1.5V(Max.) when pulse width of overshoot is less than 10ns.

\*\* : −1.5V(Min.) when pulse width of undershoot is less than 10ns.

## ELECTRICAL CHARACTERISTICS

### DC Characteristics

(V<sub>CC</sub> = 3.3 V ± 0.3 V, Ta = 0 to 70°C)

parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I <sub>LI</sub>	V <sub>I</sub> = 0 to V <sub>CC</sub>	—	—	10	μA
Output leakage current	I <sub>LO</sub>	V <sub>O</sub> = 0 to V <sub>CC</sub>	—	—	10	μA
V <sub>CC</sub> power supply current (Standby)	I <sub>CCSC</sub>	CE# = V <sub>CC</sub>	—	—	10	μA
	I <sub>CCST</sub>	CE# = V <sub>IH</sub>	—	—	1	mA
V <sub>CC</sub> power supply current (Read)	I <sub>CCA</sub>	CE# = V <sub>IL</sub> , OE# = V <sub>IH</sub> f=5MHz	—	—	16	mA
V <sub>PP</sub> power supply current	I <sub>PP</sub>	V <sub>PP</sub> = V <sub>CC</sub>	—	—	10	μA
Input “H” level	V <sub>IH</sub>	—	2.2	—	V <sub>CC</sub> +0.5*	V
Input “L” level	V <sub>IL</sub>	—	−0.5**	—	0.6	V
Output “H” level	V <sub>OH</sub>	I <sub>OH</sub> = −2 mA	2.4	—	—	V
Output “L” level	V <sub>OL</sub>	I <sub>OL</sub> = 4 mA	—	—	0.4	V

Voltage is relative to V<sub>SS</sub>.\* : V<sub>CC</sub>+1.5V(Max.) when pulse width of overshoot is less than 10ns.

\*\* : −1.5V(Min.) when pulse width of undershoot is less than 10ns.

### AC Characteristics

(V<sub>CC</sub> = 3.3 V ± 0.3 V, Ta = 0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t <sub>C</sub>	—	80	—	ns
Address access time	t <sub>ACC</sub>	CE# = OE# = V <sub>IL</sub>	—	80	ns
CE# access time	t <sub>CE</sub>	OE# = V <sub>IL</sub>	—	80	ns
OE# access time	t <sub>OE</sub>	CE# = V <sub>IL</sub>	—	30	ns
Output disable time	t <sub>CHZ</sub>	OE# = V <sub>IL</sub>	0	20	ns
	t <sub>OHZ</sub>	CE# = V <sub>IL</sub>	0	20	ns
Output hold time	t <sub>OH</sub>	CE# = OE# = V <sub>IL</sub>	0	—	ns

#### Measurement conditions

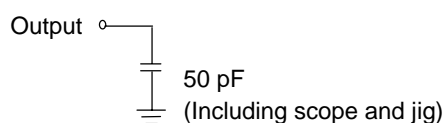
Input signal level ----- 0 V / 3 V

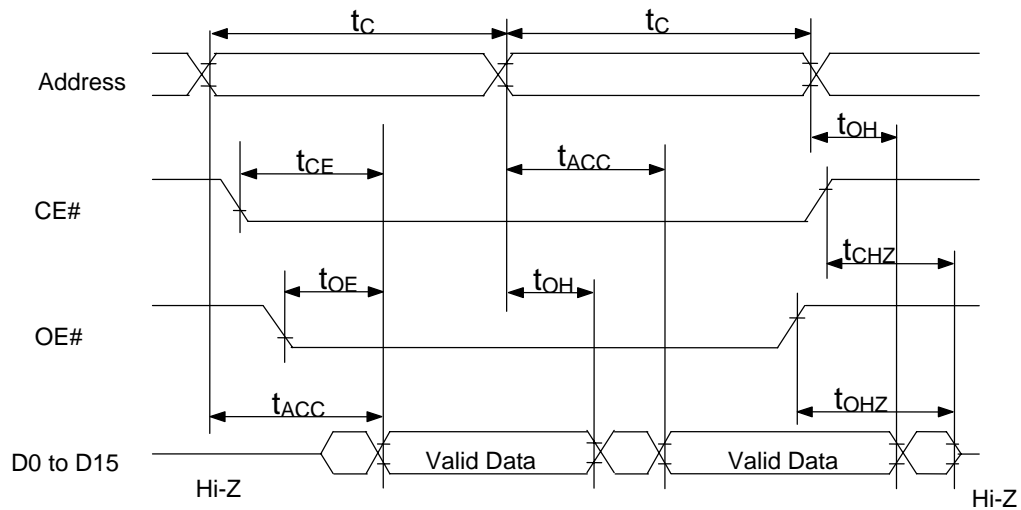
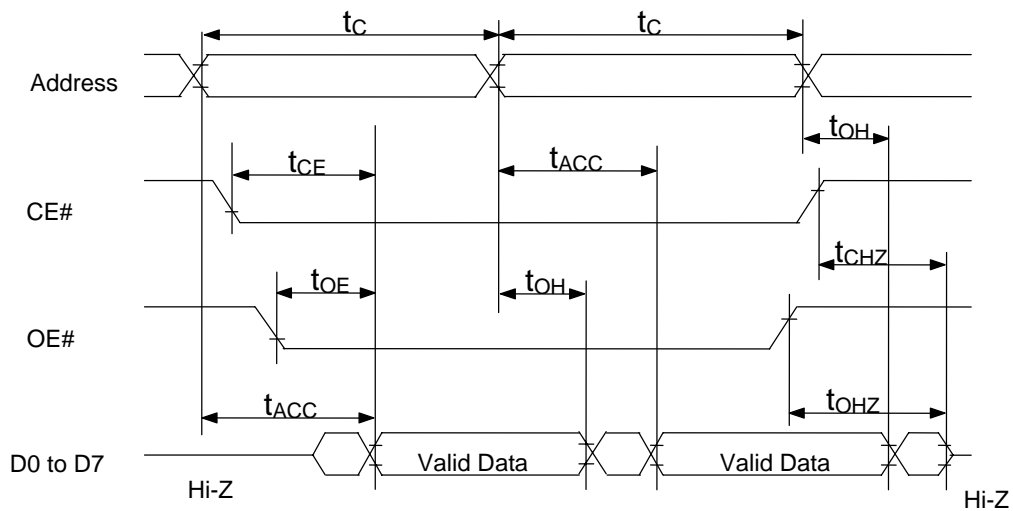
Input timing reference level----- 1/2 V<sub>CC</sub>

Output load ----- 50 pF

Output timing reference level ----- 1/2 V<sub>CC</sub>

#### Output load



**TIMING CHART (READ CYCLE)****16-BIT READ MODE (BYTE# = V<sub>IH</sub>)****8-BIT READ MODE (BYTE# = V<sub>IL</sub>)**

**ELECTRICAL CHARACTERISTICS (PROGRAMMING OPERATION)****DC Characteristics**

(Ta = 25°C ± 5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I <sub>LI</sub>	V <sub>I</sub> = V <sub>CC</sub> +0.5 V	—	—	10	μA
V <sub>PP</sub> power supply current (Program)	I <sub>PP2</sub>	CE# = V <sub>IL</sub>	—	—	50	mA
V <sub>CC</sub> power supply current	I <sub>CC</sub>	—	—	—	50	mA
Input "H" level	V <sub>IH</sub>	—	3.0	—	V <sub>CC</sub> +0.5	V
Input "L" level	V <sub>IL</sub>	—	−0.5	—	0.8	V
Output "H" level	V <sub>OH</sub>	I <sub>OH</sub> = −400 μA	2.4	—	—	V
Output "L" level	V <sub>OL</sub>	I <sub>OL</sub> = 2.1 mA	—	—	0.45	V
Program voltage	V <sub>PP</sub>	—	7.95	8.2	8.45	V
V <sub>CC</sub> power supply voltage	V <sub>CC</sub>	—	3.9	4.0	4.1	V

Voltage is relative to V<sub>SS</sub>.**AC Characteristics**(V<sub>CC</sub> = 4.0 V ± 0.1 V, BYTE#/V<sub>PP</sub> = 8.2 V ± 0.25 V, Ta = 25°C ± 5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Address set-up time	t <sub>AS</sub>	—	100	—	—	ns
OE# set-up time	t <sub>OES</sub>	—	2	—	—	μs
Data set-up time	t <sub>DS</sub>	—	100	—	—	ns
Address hold time	t <sub>AH</sub>	—	2	—	—	μs
Data hold time	t <sub>DH</sub>	—	100	—	—	ns
Output float delay time from OE#	t <sub>OHZ</sub>	—	0	—	100	ns
V <sub>PP</sub> voltage set-up time	t <sub>VS</sub>	—	2	—	—	μs
Program pulse width	t <sub>PW</sub>	—	9	10	11	μs
Data valid from OE#	t <sub>OE</sub>	—	—	—	100	ns
Address hold from OE# high	t <sub>AOH</sub>	—	0	—	—	ns

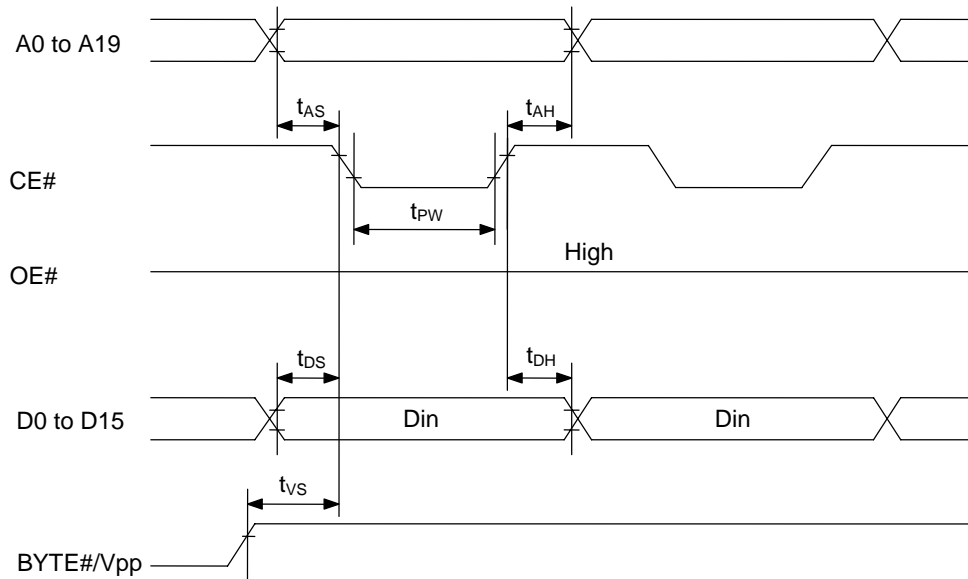
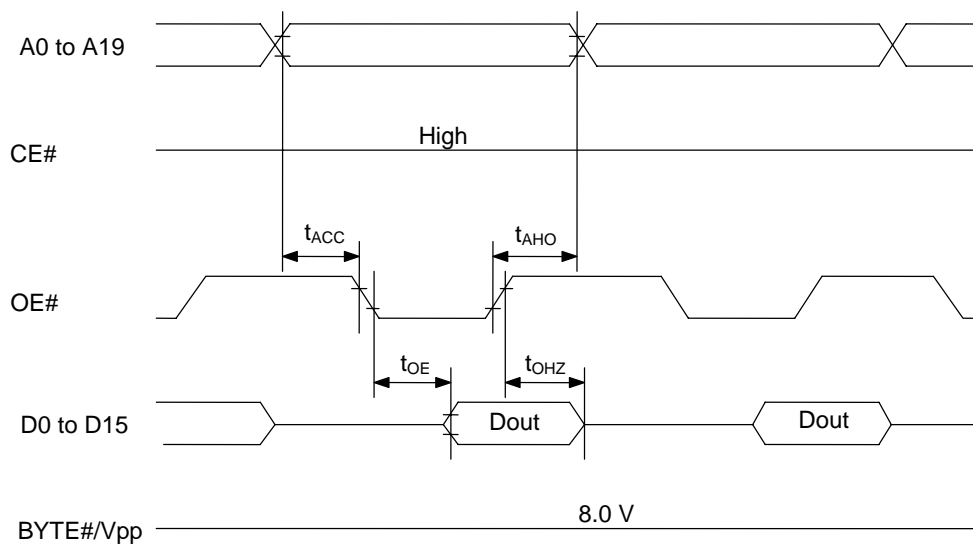
**Pin Check Function**

Pin Check Function is to check contact between each device-pin and each socket-lead with EPROM programmer. Setting up address as following condition call the preprogrammed codes on device outputs.

(V<sub>CC</sub> = 3.3 V ± 0.1 V, CE# = V<sub>IL</sub>, OE# = V<sub>IL</sub>, BYTE#/V<sub>PP</sub> = V<sub>IH</sub>, Ta = 25°C ± 5°C)

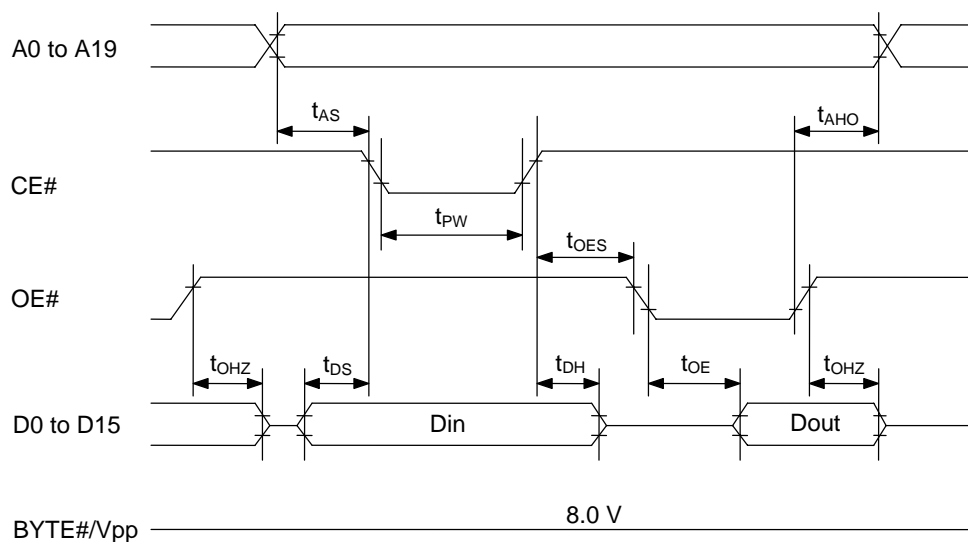
A0	A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12	A13	A14	A15	A16	A17	A18	A19	DATA
0	1	0	1	0	1	0	1	0	VH*	0	1	0	1	0	1	0	0	1	1	FF00
1	0	1	0	1	0	1	0	1	VH*	1	0	1	0	1	0	1	1	0	0	00FF
Other conditions																				FFFF

\*: VH = 7.0V ± 0.25 V

**Consecutive Programming Waveforms****Consecutive Program Verify Waveforms**



### Program and Program Verify Cycle Waveforms

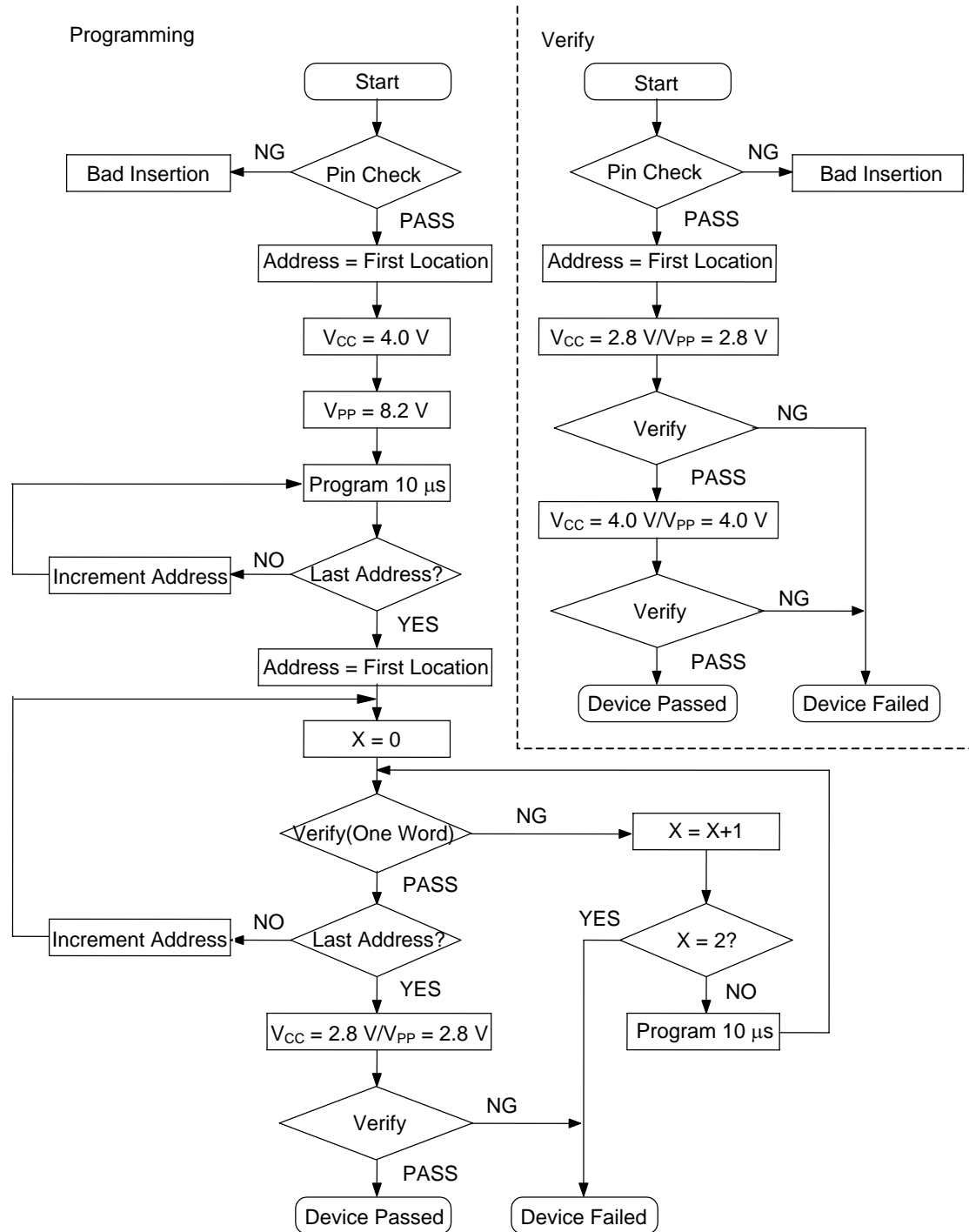


### Pin Capacitance

( $V_{CC} = 3.3 \text{ V}$ ,  $T_a = 25^\circ\text{C}$ ,  $f = 1 \text{ MHz}$ )

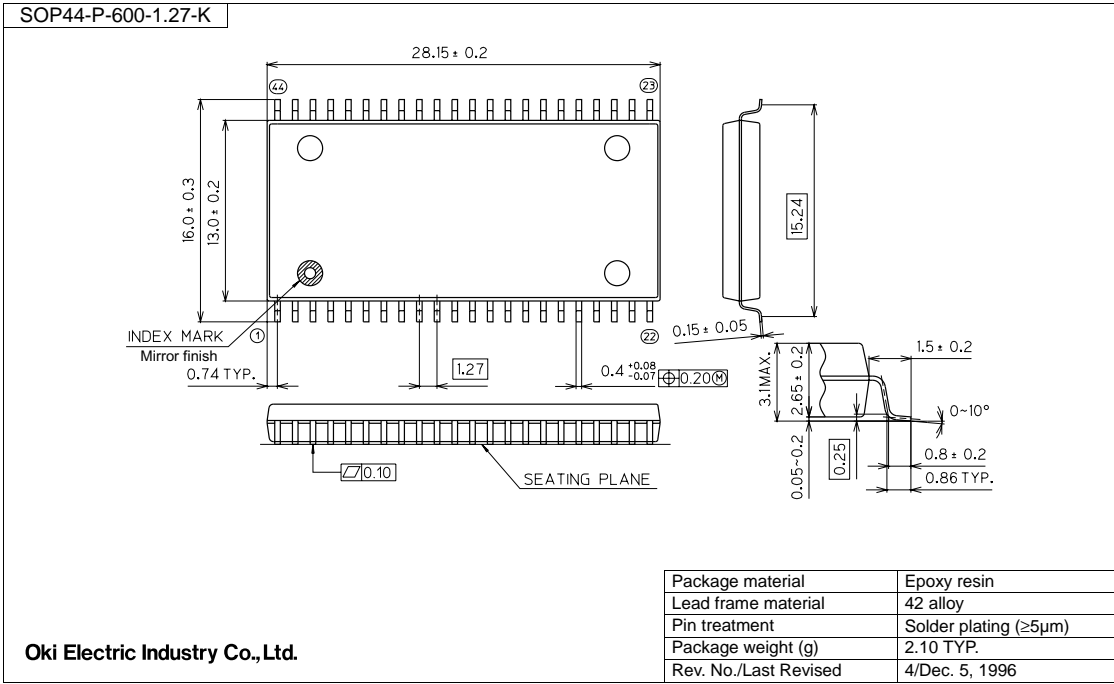
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	$C_{IN1}$	$V_I = 0 \text{ V}$	—	—	8	pF
BYTE#/V <sub>PP</sub>	$C_{IN2}$		—	—	120	
Output	$C_{OUT}$	$V_O = 0 \text{ V}$	—	—	10	

## Programming/Verify Flow Chart



PACKAGE DIMENSIONS

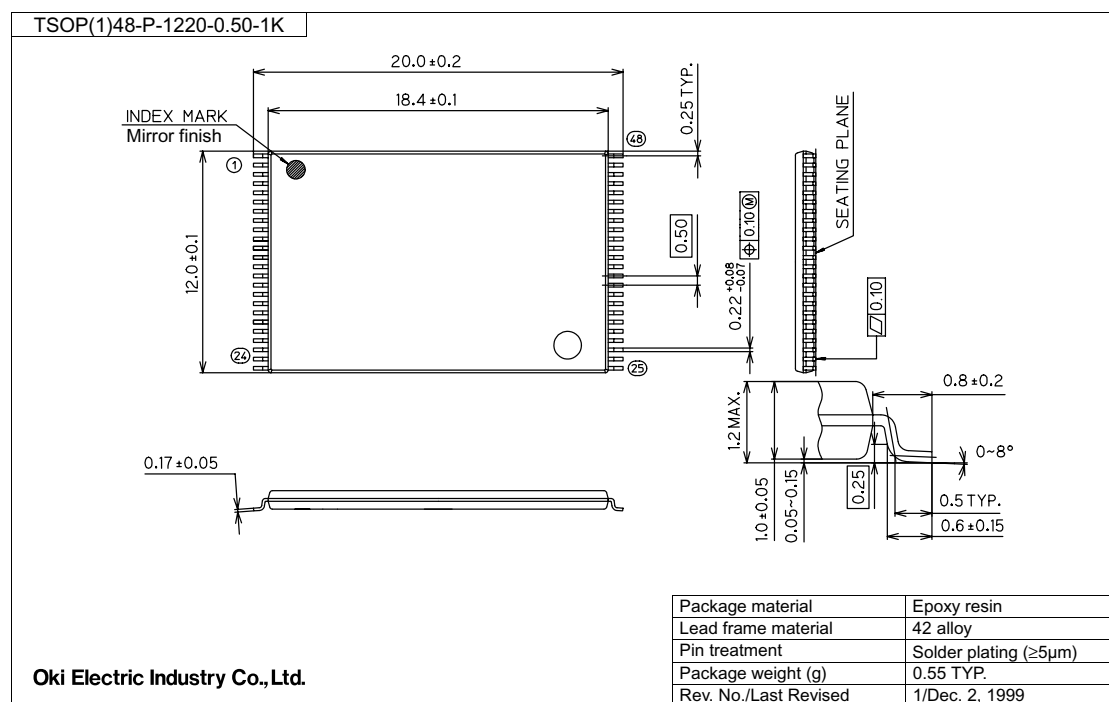
(Unit: mm)



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

(Unit: mm)



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**REVISION HISTORY**

Document No.	Date	Page		Description
		Previous Edition	Current Edition	
FEDR27V1602F-01-01	Apr. 20, 2004	–	–	Final edition 1
FEDR27V1602F-01-02	Jul. 9, 2004	4	4	Add P <sub>D</sub> condition and I <sub>OS</sub> = 10mA

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